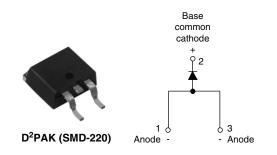


Vishay High Power Products

Fast Soft Recovery Rectifier Diode, 20 A



PRODUCT SUMMARY							
V _F at 20 A	< 1.31 V						
I _{FSM}	355 A						
V _{RRM}	800 V to 1200 V						

FEATURES/DESCRIPTION

The 20ETF..SPbF fast soft recovery rectifier series has been optimized for combined short reverse recovery time and low forward voltage drop.

The glass passivation ensures stable reliable operation in the most severe temperature and power cycling conditions.



RoHS* COMPLIANT HALOGEN FREE

This product series has been designed and qualified for industrial level.

Compliant to RoHS directive 2002/95/EC.

Halogen-free according to IEC 61249-2-21 definition.

APPLICATIONS

- Output rectification and freewheeling in inverters, choppers and converters
- Input rectifications where severe restrictions on conducted EMI should be met

MAJOR RATINGS AND CHARACTERISTICS									
SYMBOL	CHARACTERISTICS	VALUES	UNITS						
I _{F(AV)}	Sinusoidal waveform	20	A						
V _{RRM}		800 to 1200	V						
I _{FSM}		355	A						
V _F	20 A, T _J = 25 °C	1.31	V						
t _{rr}	1 A, 100 A/µs	95	ns						
TJ	Range	- 40 to 150	°C						

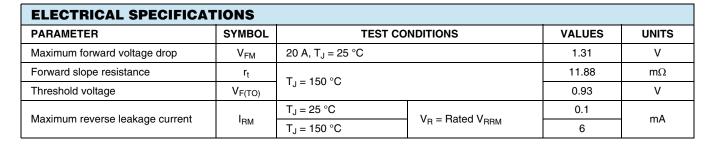
VOLTAGE RATINGS									
PART NUMBER	V _{RRM} , MAXIMUM PEAK REVERSE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I _{RRM} AT 150 °C mA						
20ETF08SPbF	800	900							
20ETF10SPbF	1000	1100	6						
20ETF12SPbF	1200	1300							

ABSOLUTE MAXIMUM RATINGS									
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS					
Maximum average forward current	I _{F(AV)}	$T_C = 97 \ ^{\circ}C$, 180° conduction half sine wave	20						
Maximum peak one cycle	I _{FSM}	10 ms sine pulse, rated V _{RRM} applied	А						
non-repetitive surge current		10 ms sine pulse, no voltage reapplied							
Maximum I ² t for fusing	l ² t	10 ms sine pulse, rated V _{RRM} applied 450		A ² s					
Maximum 1-t for fusing	1-1	10 ms sine pulse, no voltage reapplied 635		A-S					
Maximum I²√t for fusing	l²√t	t = 0.1 ms to 10 ms, no voltage reapplied	6350	A²√s					

* Pb containing terminations are not RoHS compliant, exemptions may apply

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RECOVERY CHARACTERISTICS									
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS					
Reverse recovery time	t _{rr}	I _F at 20 Apk	400	ns					
Reverse recovery current	I _{rr}	25 A/µs	6.1	А	$t_a \mid t_b$				
Reverse recovery charge	Q _{rr}	25 °C	1.7	μC					
Snap factor	S	Typical	0.6						

THERMAL - MECHANICAL SPECIFICATIONS									
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS					
Maximum junction and storage temperature range	T _J , T _{Stg}		- 40 to 150	°C					
Maximum thermal resistance, junction to case	R _{thJC}	DC operation	0.9	°C/W					
Maximum thermal resistance, junction to ambient (PCB mount)	R _{thJA} ⁽¹⁾		62	°C/W					
Soldering temperature	Τs		240	°C					
Approximate weight			2	g					
Approximate weight			0.07	oz.					
			20ETF08S						
Marking device		Case style D ² PAK (SMD-220)	20ETF10S						
			20ETF12S						

Note

⁽¹⁾ When mounted on 1" square (650 mm²) PCB of FR-4 or G-10 material 4 oz. (140 μm) copper 40 °C/W For recommended footprint and soldering techniques refer to application note #AN-994





Fast Soft Recovery Rectifier Diode, 20 A Vishay High Power Products

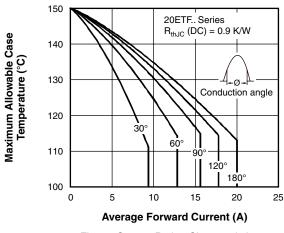


Fig. 1 - Current Rating Characteristics

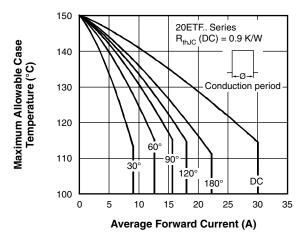


Fig. 2 - Current Rating Characteristics

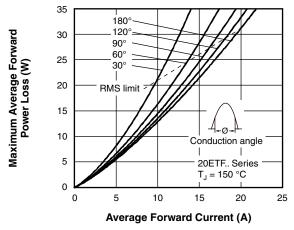


Fig. 3 - Forward Power Loss Characteristics

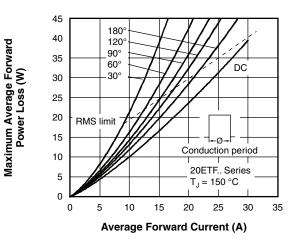


Fig. 4 - Forward Power Loss Characteristics

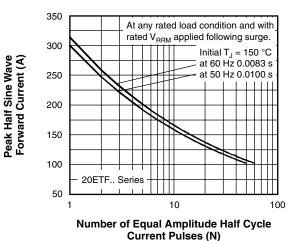
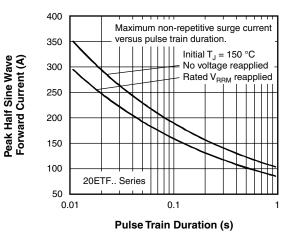


Fig. 5 - Maximum Non-Repetitive Surge Current





Vishay High Power Products

Fast Soft Recovery Rectifier Diode, 20 A

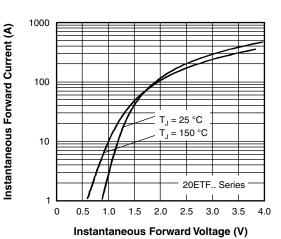


Fig. 7 - Forward Voltage Drop Characteristics

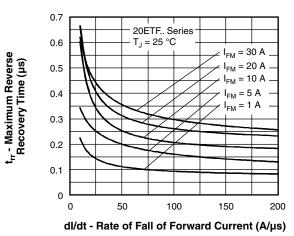


Fig. 8 - Recovery Time Characteristics, $T_J = 25 \ ^{\circ}C$

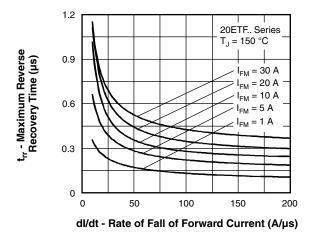
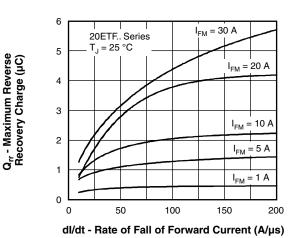
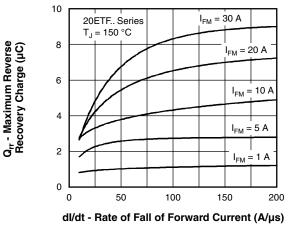
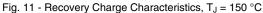


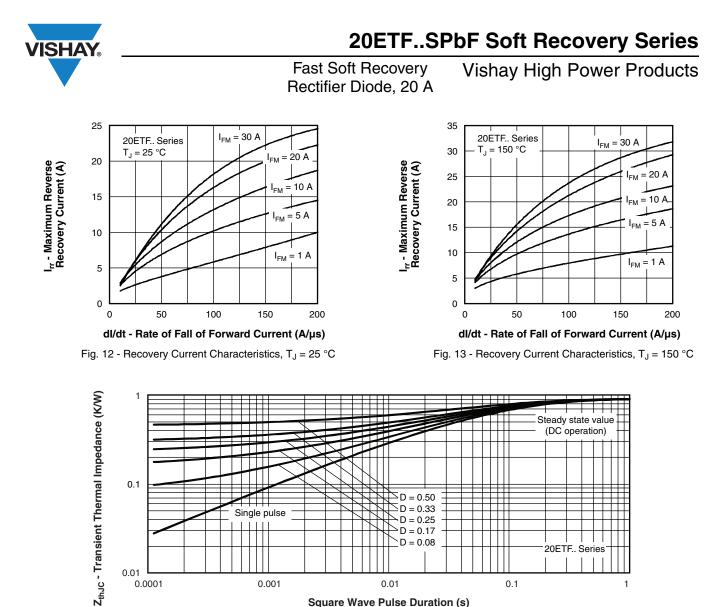
Fig. 9 - Recovery Time Characteristics, $T_J = 150 \ ^{\circ}C$











Square Wave Pulse Duration (s) Fig. 14 - Thermal Impedance Z_{thJC} Characteristics



Vishay High Power Products

Fast Soft Recovery Rectifier Diode, 20 A

ORDERING INFORMATION TABLE

Device code	20	E	т	F	12	S	TRL	PbF	
	1	2	3	4	5	6	7	8	
	1 - 2 -			ng (20 = iguratior					
	3 -	Pac	E = Single diode Package: T = D ² PAK (TO-220AC)						
	4 -	Тур	Type of silicon:						
	5 - 6 -			le x 100 e mounta		1	- 10 =	800 V 1000 V 1200 V	
	7 -	• TF		pe and					
	8 -	• No	one = St	pe and r tandard ad (Pb)-1	product		:d)		

LINKS TO RELATED DOCUMENTS							
Dimensions	www.vishay.com/doc?95046						
Part marking information	www.vishay.com/doc?95054						
Packaging information	www.vishay.com/doc?95032						

Outline Dimensions

Vishay Semiconductors

D²PAK



Conforms to JEDEC outline D²PAK (SMD-220) в Pad layout (2)(3)A 11.00 MIN.-(E) F (0.43)ŧ (3) L1 4 (|(0.38)^{MIN.} (D1) (3) Detail A D 17.90 (0.70) Н 15.00 (0.625) (2) З 0.15)^{0.01} Ľ L2 Ĥ ţ В В 2.32 MIN. (0.08) 2.64 (0.103) 2.41 (0.096) (3)Ċ 2 x b2 С View A - A 2 x h // ± 0.004 M B ⊕ 0.010 M A M B Base Plating (4) Metal 2 x e Н b1, b3 Gauge plane c1 (4) (c) В 0° to 8° ŧ. Seating Lead assignments plane L3 A1 Lead tip (b, b2) Diodes Section B - B and C - C 1. - Anode (two die)/open (one die) Scale: None 2., 4. - Cathode Detail "A" 3. - Anode

Rotated 90 °CW Scale: 8:1

SYMBOL	MILLIMETERS		INCHES		IES NOTES		SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES		STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
А	4.06	4.83	0.160	0.190			D1	6.86	8.00	0.270	0.315	3
A1	0.00	0.254	0.000	0.010			E	9.65	10.67	0.380	0.420	2, 3
b	0.51	0.99	0.020	0.039			E1	7.90	8.80	0.311	0.346	3
b1	0.51	0.89	0.020	0.035	4		е	2.54	BSC	0.100	BSC	
b2	1.14	1.78	0.045	0.070			Н	14.61	15.88	0.575	0.625	
b3	1.14	1.73	0.045	0.068	4		L	1.78	2.79	0.070	0.110	
с	0.38	0.74	0.015	0.029			L1	-	1.65	-	0.066	3
c1	0.38	0.58	0.015	0.023	4		L2	1.27	1.78	0.050	0.070	
c2	1.14	1.65	0.045	0.065				0.25	BSC	0.010	BSC	
D	8.51	9.65	0.335	0.380	2		L4	4.78	5.28	0.188	0.208	

Notes

 $^{(1)}\,$ Dimensioning and tolerancing per ASME Y14.5 M-1994 $\,$

(2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body

⁽³⁾ Thermal pad contour optional within dimension E, L1, D1 and E1

⁽⁴⁾ Dimension b1 and c1 apply to base metal only

⁽⁵⁾ Datum A and B to be determined at datum plane H

⁽⁶⁾ Controlling dimension: inch

⁽⁷⁾ Outline conforms to JEDEC outline TO-263AB

Document Number: 95046 For technical questions within your region, please contact one of the following: Revision: 31-Mar-11 DiodesAmericas@vishay.com, DiodesAsia@vishay.com, DiodesEurope@vishay.com

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DIMENSIONS in millimeters and inches



Vishay

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